

N-Channel Enhancement Mode MOSFET

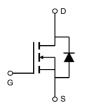
Features

- 80V/170A $R_{DS(ON)} = 3.8 \text{ m}\Omega \text{ (typ.) } @ V_{GS} = 10V$
- 100% avalanche tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

Pin Description GDS TO-220FB-3L TO-220FB-3S TO-263-2L TO-3PS-3L TO-3PS-3L TO-3PM-3S

Applications

Power Management for Inverter Systems.



N-Channel MOSFET

Ordering and Marking Information



Note: HUAYI lead -free products contain molding compounds/die attach materials and 100% matte tin plate Termination finish; which are fully compliant with RoHS. HUAYI lead -free products meet or exceed the lead-Free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit				
Common	Common Ratings (T _c =25°C Unless Otherwise Noted)						
V _{DSS}	Drain-Source Voltage		80	V			
V _{GSS}	Gate-Source Voltage		±25				
TJ	Maximum Junction Temperature		175	°C			
T _{STG}	Storage Temperature Range		-55 to 175	°C			
Is	Diode Continuous Forward Current	T _C =25°C	170	А			
Mounted	Mounted on Large Heat Sink						
I _{DM}	Pulsed Drain Current *	T _C =25°C	660**	А			
	Continuous Drain Current	T _C =25°C	170	A			
l _D	Continuous Diairi Curient	T _C =100°C	114				
P _D	Maximum Dower Discipation	T _C =25°C	288	W			
FD	Maximum Power Dissipation T _c =100°C		144	7 vv			
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.52	°C/W				
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62.5					
Avalanch	e Ratings		•	-			
E _{AS}	Avalanche Energy, Single Pulsed	L=0.5mH	1168***	mJ			

Note: * Repetitive rating; pulse width limited by junction temperature
** Drain current is limited by junction temperature

Electrical Characteristics (T_c = 25°C Unless Otherwise Noted)

Symbol Parameter		Test Conditions		HY3708		Unit
Symbol	Parameter	rest Conditions	Min.	Тур.	Max.	
Static Cha	aracteristics				,	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	80	-	-	V
	V _{DS} =80V, V _{GS} =0V		-	-	1	
I _{DSS}	Zero Gate Voltage Drain Current	T _J =85°C	-	-	10	μΑ
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_{DS} =250μA	2.0	3.0	4.0	V
I _{GSS}	Gate Leakage Current	V_{GS} =±25V, V_{DS} =0V	-	-	±100	nA
R _{DS(ON)} *	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =85A	-	3.8	5.0	mΩ
Diode Cha	Diode Characteristics					
V _{SD} *	Diode Forward Voltage	I _{SD} =85 A, V _{GS} =0V	-	8.0	1.2	V
t _{rr}	Reverse Recovery Time	_05		30	-	ns
Q _{rr}	Reverse Recovery Charge	l _{SD} =85 A, dl _{SD} /dt=100A/μs	-	52	-	nC

^{***} VD=64V



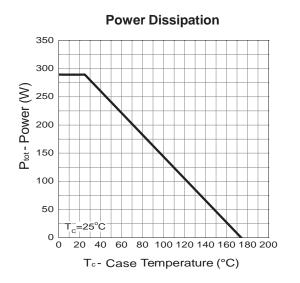
Electrical Characteristics (Cont.) $(T_c = 25^{\circ}C \text{ Unless Otherwise Noted})$

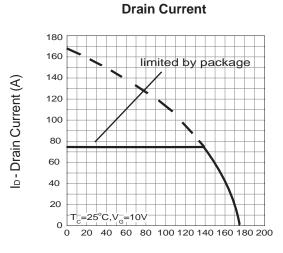
Symbol	Parameter	Test Conditions	HY3708			Unit
Symbol	Parameter	rest Conditions	Min.	Тур.	Max.	Offic
Dynamic (Dynamic Characteristics					
R_G	Gate Resistance	V _{GS} =0V,V _{DS} =0V,F=1MHz	-	1.8	-	Ω
C _{iss}	Input Capacitance	$V_{GS}=0V$,	-	6109	-	
C _{oss}	Output Capacitance	V _{DS} =25V,	-	995	-	pF
C _{rss}	Reverse Transfer Capacitance	Frequency=1.0MHz	-	530	-	
t _{d(ON)}	Turn-on Delay Time	V_{DD} =40V, R _G =6 Ω , I_{DS} =85A, V _{GS} =10V,	-	28	-	
Tr	Turn-on Rise Time		-	18	-	ns
t _{d(OFF)}	Turn-off Delay Time		-	42	-	115
T_f	Turn-off Fall Time		-	54	-	
Gate Charge Characteristics						
Q_g	Total Gate Charge			152	-	
Q_gs	Gate-Source Charge	V_{DS} =64V, V_{GS} =10V, I_{DS} =85A	-	25	-	nC
Q_gd	Gate-Drain Charge	103 0000	-	53	-	

Note * : Pulse test ; pulse width $\leq\!300\mu s,$ duty cycle $\!\leq\!2\%.$



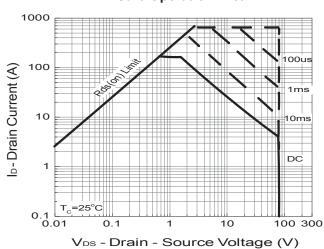
Typical Operating Characteristics



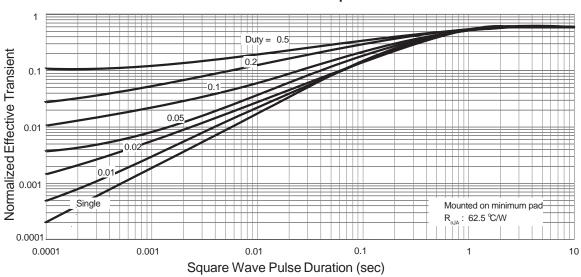


T_c-Case Temperature (°C)

Safe Operation Area

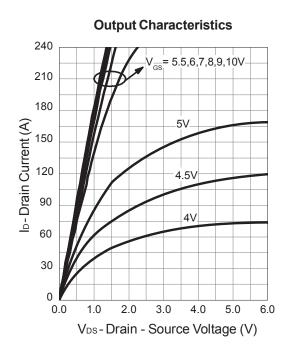


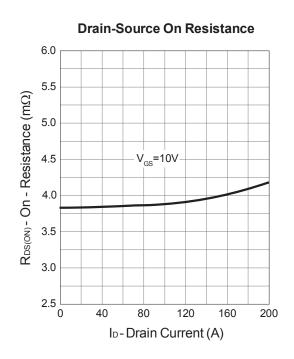
Thermal Transient Impedance

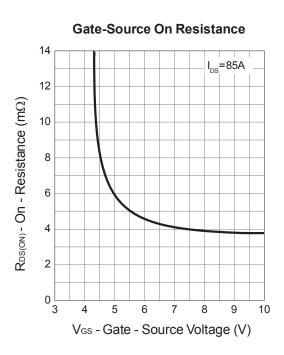


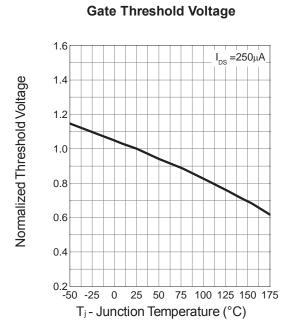


Typical Operating Characteristics (Cont.)





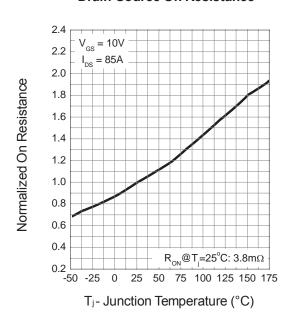




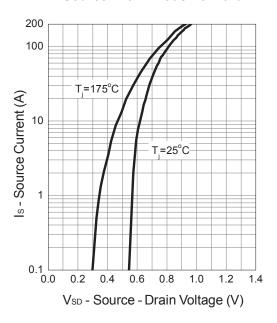


Typical Operating Characteristics (Cont.)

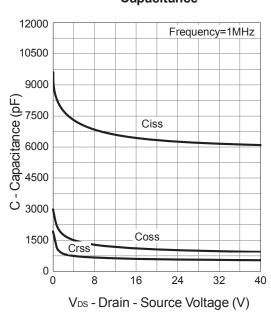
Drain-Source On Resistance



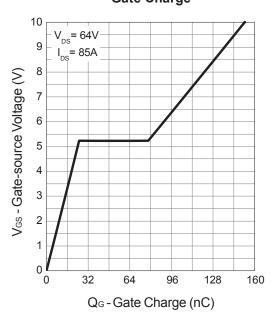
Source-Drain Diode Forward



Capacitance

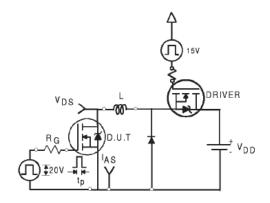


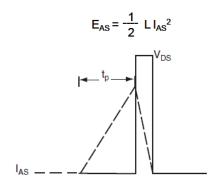
Gate Charge



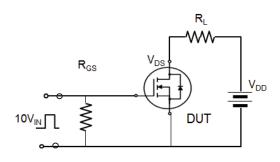


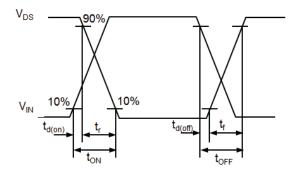
Avalanche Test Circuit



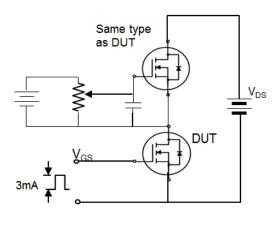


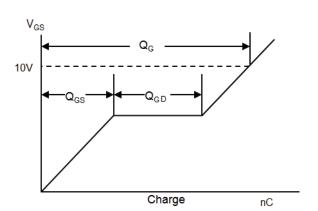
Switching Time Test Circuit





Gate Charge Test Circuit



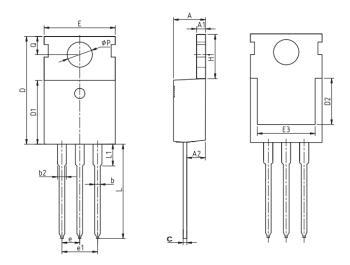




Package Type	Unit	Quantity
TO-220FB-3L	Tube	50

Package Information

TO-220FB-3L



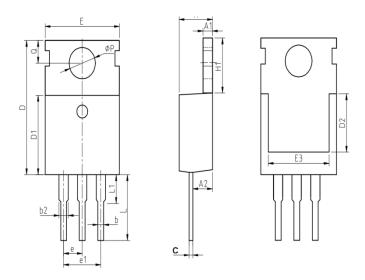
SYMBOL	mm			
STIVIBOL	MIN	NOM	MAX	
Α	4.37	4.57	4.77	
A1	1.25	1.30	1.45	
A2	2.20	2.40	2.60	
b	0.70	0.80	0.95	
b2	1.17	1.27	1.47	
С	0.40	0.50	0.65	
D	15.10	15.60	16.10	
D1	8.80	9.10	9.40	
D2	5.50	-	-	
E	9.70	10.00	10.30	
E3	7.00	-	-	
е		2.54 BSC		
e1		5.08 BSC		
H1	6.25	6.50	6.85	
L	12.75	13.50	13.80	
L1	-	3.10	3.40	
ФР	3.40	3.60	3.80	
Q	2.60	2.80	3.00	



Package Type	Unit	Quantity
TO-220FB-3S	Tube	50

Package Information

TO-220FB-3S



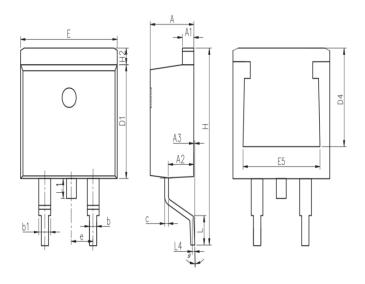
CVMDOL	mm			
SYMBOL	MIN	NOM	MAX	
А	4.37	4.57	4.77	
A1	1.25	1.30	1.45	
A2	2.20	2.40	2.60	
b	0.70	0.80	0.95	
b2	1.17	1.27	1.47	
С	0.40	0.50	0.65	
D	15.10	15.60	16.10	
D1	8.10	9.10	9.40	
D2	5.50	-	-	
E	9.70	10.00	10.30	
E3	7.00	-	-	
е		2.54 BSC		
e1		5.08 BSC		
H1	6.25	6.50	6.85	
L	6.80	7.00	7.20	
L1	-	3.10	3.40	
ФР	3.40	3.60	3.80	
Q	2.60	2.80	3.00	



Package Type	Unit	Quantity
TO-263-2L	Reel	50

Package Information

TO-263-2L



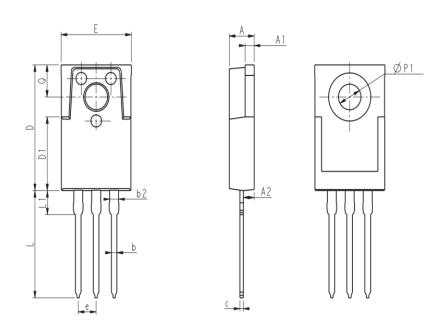
SYMBOL		mm	
STIVIBOL	MIN	NOM	MAX
А	4.37	4.57	4.77
A1	1.22	1.27	1.42
A2	2.49	2.69	2.89
A3	0	0.13	0.25
b	0.7	0.81	0.96
b1	1.17	1.27	1.47
С	0.3	0.38	0.53
D1	8.5	8.7	8.9
D4	6.6	-	-
Е	9.86	10.16	10.36
E5	7.06	-	-
е		2.54 BSC	;
Н	14.7	15.1	15.5
H2	1.07	1.27	1.47
L	2	2.3	2.6
L1	1.4	1.55	1.7
L4	0.25 BSC		
θ	0°	5°	9°



Package Type	Unit	Quantity
TO-3PS-3L	Tube	50

Package Information

TO-3PS-3L



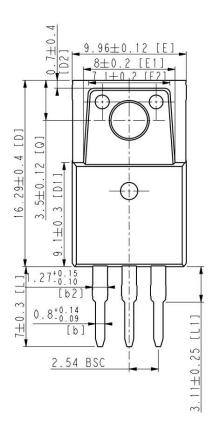
CVMDOL	mm			
SYMBOL	MIN	NOM	MAX	
А	3.36	3.56	3.76	
A1	1.25	1.30	1.40	
A2	1.39	1.54	1.69	
b	0.75	0.80	0.90	
b2	1.17	1.27	1.42	
С	0.45	0.50	0.60	
D	15.45	15.70	15.95	
D1	9.00	9.20	9.40	
E	9.88	10.00	10.20	
е	2	.54 BS	С	
L	13.20	13.40	13.60	
L1	-	3.00	3.30	
ФР1	3.20 REF			
Q	3.88	4.00	4.12	

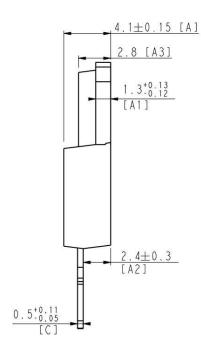


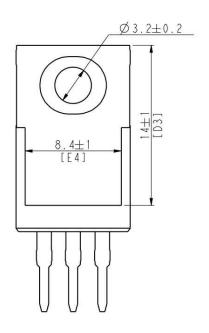
Package Type	Unit	Quantity
TO-3PM-3S	Tube	50

Package Information

TO-3PM-3S

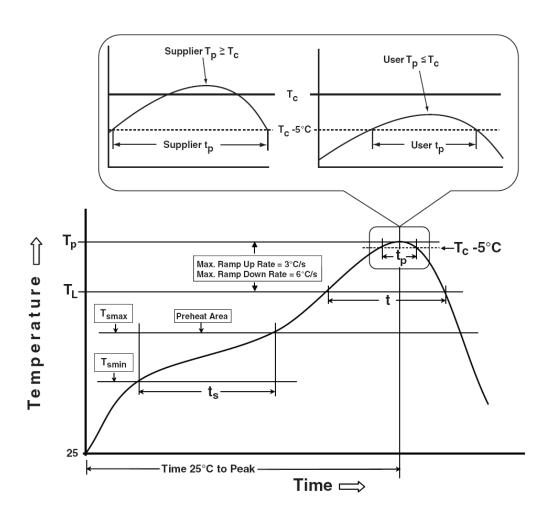








Classification Profile



Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly	
$\begin{array}{c} \textbf{Preheat \& Soak} \\ \textbf{Temperature min (T}_{smin}) \\ \textbf{Temperature max (T}_{smax}) \\ \textbf{Time (T}_{smin} \text{ to T}_{smax}) \text{ (t}_{s}) \end{array}$	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds	
Average ramp-up rate (T _{smax} to T _P)	3 °C/second max.	3°C/second max.	
Liquidous temperature (T _L) Time at liquidous (t _L)	183 °C 60-150 seconds	217 °C 60-150 seconds	
Peak package body Temperature $(T_p)^*$	See Classification Temp in table 1	table 1 See Classification Temp in table 2	
Time (t _P)** within 5°C of the specified classification temperature (T _c)	20** seconds	30** seconds	
Average ramp-down rate (T _p to T _{smax})	6 °C/second max.	6 °C/second max.	
Time 25°C to peak temperature	6 minutes max. 8 minutes max		

^{*} Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

HY3708P/M/B/PS/PM



Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm ³ <350	Volume mm³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb_free Process _ Classification Temperatures (Tc)

Package	Volume mm ³	Volume mm ³	Volume mm ³
Thickness	<350	350-2000	>2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168 Hrs/500 Hrs/1000 Hrs, Bias @ 125°C
PCT	JESD-22, A102	96 Hrs, 100 % RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -55°C~150°C

Customer Service

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